

RECORDATION FORM COVER SHEET

To the Honorable Commissioner of Patents and Trademarks:
Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Wen-Ching SUN, Tzer-Shen LIN, Sheng-Min YU
Additional name(s) of conveying parties attached?
 Yes No

2. Name and address of receiving party(ies)
Name: **Industrial Technology Research Institute**
Internal Address:
Street Address: **No. 195, Sec. 4, Chung Hsing Road, Chungung**
City: **Hsinchu** State: Zip: **31040**
Country: **TW**
Additional names(s) & address(es) attached?
 Yes No

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of name
 Other:

Execution Date: **2/25/2011**

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the new application is:

A. Patent Application No.(s):
13/084,486

B. Patent No.(s):

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning this document should be mailed.
Name: **Quintero Law Office, PC**
Street Address: **615 Hampton Drive, Suite A202**
City: **Venice** State: **CA** Zip: **90291**

6. Total number of applications and patents involved: **1**

7. Total fee (37 C.F.R. 3.41): **\$40**

Enclosed

Authorized to be charged to credit card (Form PTO-2038 attached)

Authorized to be charged to deposit account, if no fee attached.

8. Deposit account number: **502447**

(Attach duplicate cover sheet if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Nelson A. Quintero, #52,143

Name of person signing



Signature

April 12, 2011

Date

Total number of pages including cover sheet, attachments, and documents: **2**

CH \$40.00 502447 13084486

ASSIGNMENT

WHEREAS, Wen-Ching SUN, Tzer-Shen LIN and Sheng-Min YU hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: PASSIVATION LAYER STRUCTURE OF SEMICONDUCTOR DEVICE AND METHOD FOR FORMING THE SAME

Serial No _____

Executed on: 2011/2/25

WHEREAS, Industrial Technology Research Institute of No. 195, Sec. 4, Chung Hsing Dist., Hsinchu City, 31010, Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Full name of sole or first inventor: Wen-Ching SUN	
Inventor's signature: <i>Sun Wen Ching</i>	Date: 2011. 2. 25

Full name of second inventor: Tzer-Shen LIN	
Inventor's signature: <i>Tzer-Shen Lin</i>	Date: 2011. 02. 25

Full name of third inventor: Sheng-Min YU	
<i>Yu Sheng Min</i>	

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wen-Ching SUN, Tzer-Shen LIN,
Sheng-Min YU

Filed: 4/11/2011

Appl. No.: 13/084,486

Examiner:

Conf. No.: 1208

Art Unit:

Title: PASSIVATION LAYER STRUCTURE OF SEMICONDUCTOR DEVICE AND
METHOD FOR FORMING THE SAME

Date: April 12, 2011

Mail Stop Assignment Recordation Services
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RECORDATION OF ASSIGNMENT

Attached please find the following documents:

1. Recordation form cover sheet (1 page); and
2. Assignment (1 page(s)).

Certificate of Transmission

I hereby certify that this correspondence is being
facsimile transmitted to the United States Patent and
Trademark Office (fax no. (571) 273-0140) on the date
shown below:

Nelson A. Quintero

(Name of Person Depositing)



(Signature)

April 12, 2011

(Date)

Respectfully submitted,



Nelson A. Quintero
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Reg. No. 52,143
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